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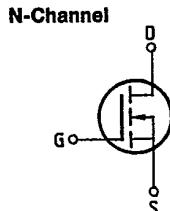
88D 14486 D T-39-13

BUZ 17

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Main ratings

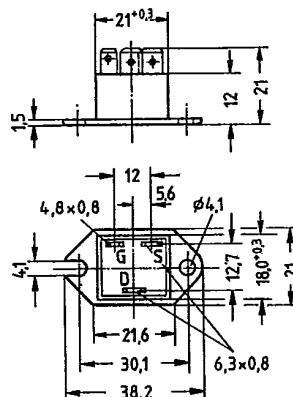
$$\begin{array}{lll} \textbf{Drain-source voltage} & V_{DS} & = 50 \text{ V} \\ \textbf{Continuous drain current} & I_D & = 32 \text{ A} \\ \textbf{Drain-source on-resistance} & R_{DS(on)} & = 0,04 \Omega \end{array}$$



Description SIPMOS, N-channel, enhancement mode

Case Plastic package TO 238 AA with insulated metal base plate in accordance with JEDEC, compatible with TO 3; AMP plug-in connections.
Approx. weight 21 g

Type	Ordering code
BUZ 17	C67078-A1600-A2



Dimensions in mm

Maximum ratings

Description	Symbols	Ratings	Units	Conditions
Drain-source voltage	V_{DS}	50	V	
Drain-gate voltage	V_{DGR}	50	V	$R_{GS} = 20 \text{ k}\Omega$
Continuous drain current	I_D	32	A	$T_C = 25^\circ\text{C}$
Pulsed drain current	$I_{D\text{puls}}$	125	A	$T_C = 25^\circ\text{C}$
Gate-source voltage	V_{GS}	± 20	V	
Max. power dissipation	P_D	83,3	W	$T_C = 25^\circ\text{C}$
Operating and storage temperature range	T_J			
Isolation test voltage	T_{stg}	-40 ... +150	°C	
DIN humidity category	V_{ls}	3500	Vdc ¹⁾	$t = 1 \text{ min}$
IEC climatic category		F	-	DIN 40040
		40/150/56		DIN IEC 68-1

Thermal resistance

Thermal resistance	R_{thJC}	$\leq 1,5$	K/W
Chip – case			

¹⁾ Isolation test voltage between drain and base plate referred to standard climate 23/50 in accordance with DIN 50014.

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Electrical characteristics

(at $T_j = 25^\circ\text{C}$ unless otherwise specified)

Description	Symbol	Characteristics			Unit	Conditions
		min.	typ.	max.		

Static ratings

Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	50	65	—	V	$V_{GS} = 0\text{V}$ $I_D = 0,25\text{mA}$
Gate threshold voltage	$V_{GS(\text{th})}$	2,1	3,0	4,0		$V_{DS} = V_{GS}$ $I_D = 1\text{mA}$
Zero gate voltage drain current	I_{DSS}	— —	20 100	250 1000	μA	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$ $V_{DS} = 50\text{V}$ $V_{GS} = 0\text{V}$
Gate-source leakage current	I_{GSS}	—	10	100	nA	$V_{GS} = 20\text{V}$ $V_{DS} = 0\text{V}$
Drain-source on-resistance	$R_{DS(on)}$	—	0,035	0,04	Ω	$V_{GS} = 10\text{V}$ $I_D = 22\text{A}$

Dynamic ratings

Forward transconductance	g_{fs}	7,0	18,0	—	S pF	$V_{DS} = 25\text{V}$ $I_D = 22\text{A}$
Input capacitance	C_{iss}	—	1600	2100		$V_{GS} = 0\text{V}$
Output capacitance	C_{oss}	—	1300	2000		$V_{DS} = 25\text{V}$
Reverse transfer capacitance	C_{rss}	—	500	800		$f = 1\text{MHz}$
Turn-on time t_{on} ($t_{on} = t_{d(on)} + t_f$)	$t_{d(on)}$ t_f	— —	30 110	45 170	ns	$V_{CC} = 30\text{V}$ $I_D = 3\text{A}$ $V_{GS} = 10\text{V}$ $R_{GS} = 50\Omega$
Turn-off time t_{off} ($t_{off} = t_{d(off)} + t_f$)	$t_{d(off)}$ t_f	— —	330 250	430 330		

Reverse diode

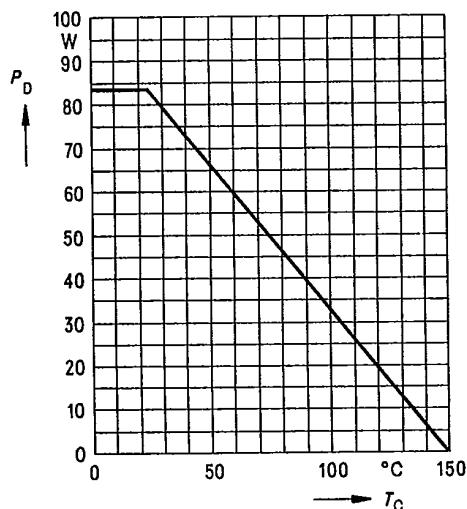
Continuous reverse drain current	I_{DR}	—	—	32	A	$T_C = 25^\circ\text{C}$
Pulsed reverse drain current	I_{DRM}	—	—	125		
Diode forward on-voltage	V_{SD}	—	1,4	2,0	V	$I_F = 2 \times I_{DR}$ $V_{GS} = 0\text{V}, T_j = 25^\circ\text{C}$
Reverse recovery time	t_{rr}	—	150	—	ns	$T_j = 25^\circ\text{C}$
Reverse recovery charge	Q_{rr}	—	1,0	—	μC	$I_F = I_{DR}$ $d_I/dt = 100\text{A}/\mu\text{s}$ $V_R = 30\text{V}$

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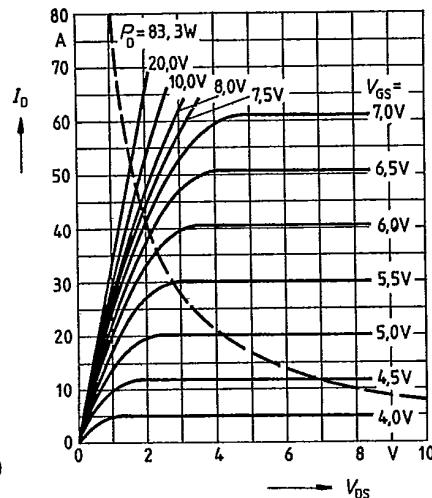
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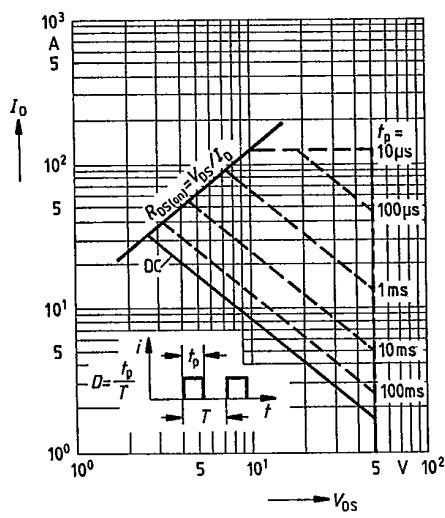
Power dissipation $P_D = f(T_C)$



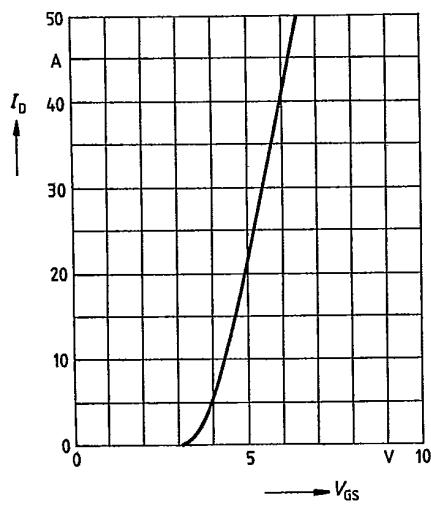
Typical output characteristics $I_D = f(V_{DS})$
parameter: 80 μ s pulse test,
 $T_j = 25^\circ\text{C}$



Safe operating area $I_D = f(V_{DS})$
parameter: $D = 0.01$, $T_C = 25^\circ\text{C}$



Typical transfer characteristic $I_D = f(V_{GS})$
parameter: 80 μ s pulse test,
 $V_{DS} = 25\text{V}$, $T_j = 25^\circ\text{C}$



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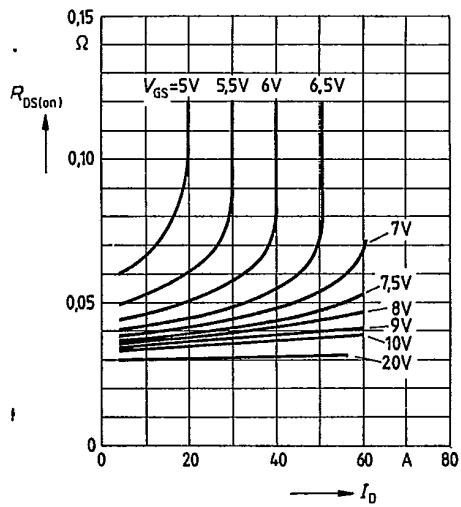
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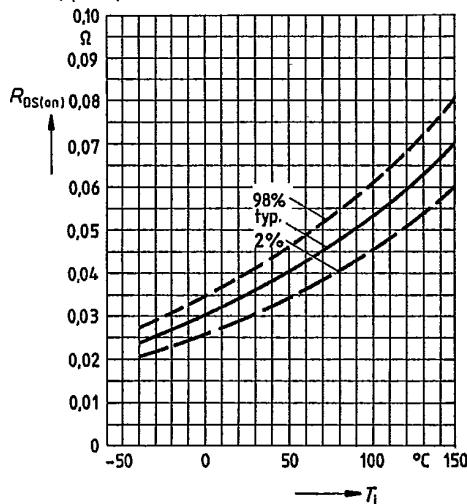
Typical drain-source on-state resistance

$R_{DS(on)} = f(I_D)$
parameter: $V_{GS} = 25V$; $T_J = 25^\circ C$



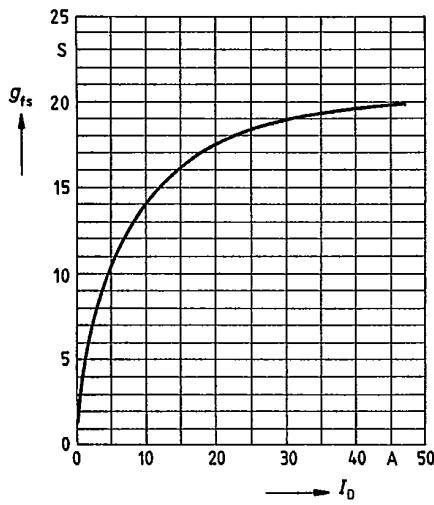
Drain-source on-state resistance

$R_{DS(on)} = f(T_J)$
parameter: $I_D = 22A$, $V_{GS} = 10V$
(spread)



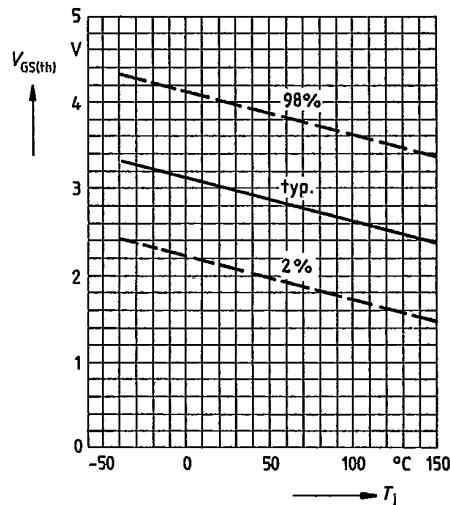
Typical transconductance $g_{fs} = f(I_D)$

parameter: 80 μs pulse test,
 $V_{DS} = 25V$, $T_J = 25^\circ C$



Gate threshold voltage $V_{GS(th)} = f(T_J)$

parameter: $V_{DS} = V_{GS}$, $I_D = 1mA$
(spread)



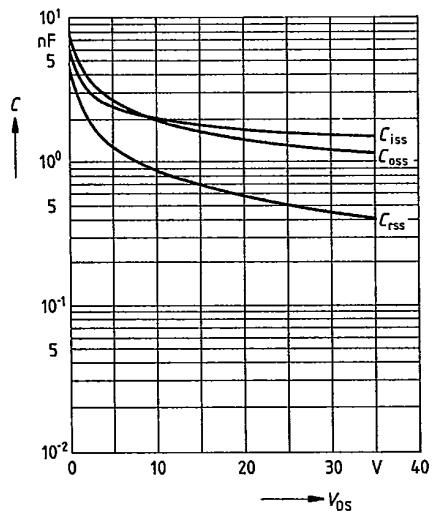
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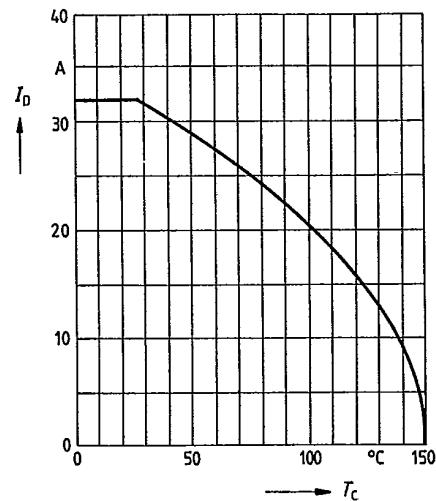
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Typical capacitances $C = f(V_{DS})$
parameter: $V_{GS} = 0$, $f = 1\text{MHz}$

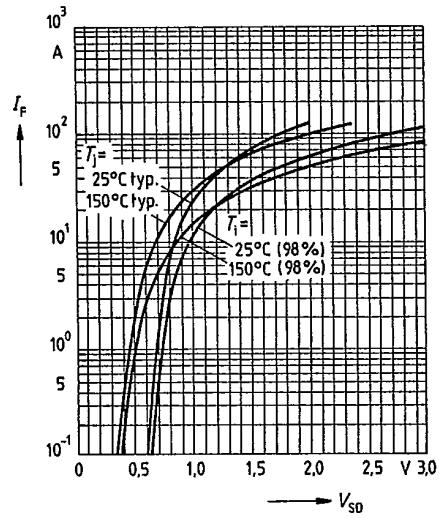


Continuous drain current $I_D = f(T_C)$
parameter: $V_{GS} \geq 10V$



Forward characteristic of reverse diode

$I_F = f(V_{SD})$
parameter: T_j , $t_p = 80 \mu\text{s}$
(spread)



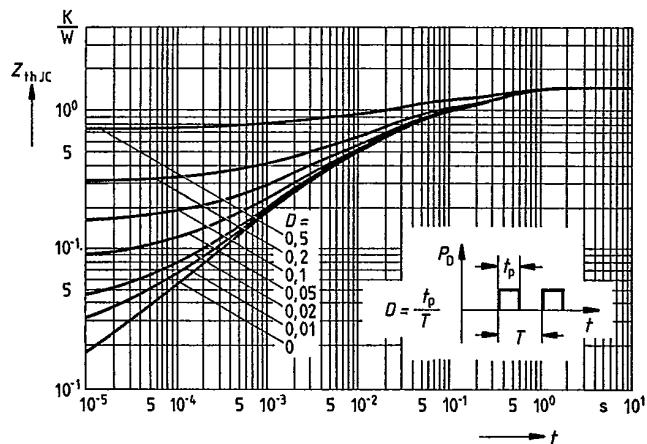
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Transient thermal impedance $Z_{thJC} = f(t)$
parameter: $D = t_p/T$



Typical gate-charge $V_{GS} = f(Q_{Gate})$
parameter: $I_D \text{ puls} = 67,5A$

